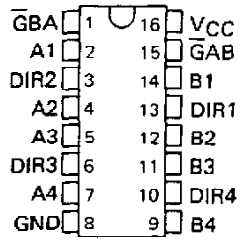
SN54LS446, SN54LS449, SN74LS446, SN74LS449
QUADRUPLE BUS TRANSCEIVERS WITH INDIVIDUAL DIRECTION CONTROLS

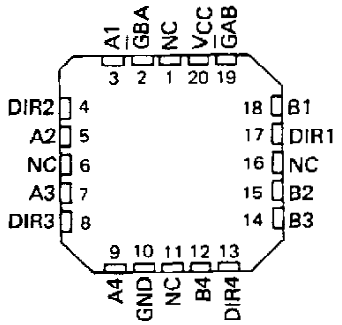
SDLS178 — D2613, OCTOBER 1980—REVISED MARCH 1988

- 3-State Outputs Drive Bus Lines Directly
- P-N-P Inputs Reduce DC Loading on Bus Line
- Hysteresis at Bus Inputs Improves Noise Margins
- Flow-Thru Data Pinout (B Bus Opposite A Bus)
- Choice of True ('LS449) and Inverting ('LS446)

SN54LS446, SN54LS449 . . . J PACKAGE
SN74LS446, SN74LS449 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS446, SN54LS449 . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

description

These quadruple bus transceivers are designed for data transmission from individual lines of the A bus to individual lines of the B bus or the reverse, depending on the logic levels at the direction-control pins DIR1 through DIR4. These direction controls (one for each channel) allow maximum flexibility in timing. The enable inputs $\overline{G}BA$ and $\overline{G}AB$ can be used to disable the A or B outputs respectively, or to disable both buses for effective isolation.

The SN54LS446 and SN54LS449 are characterized for operation over the full military temperature range of −55°C to 125°C. The SN74LS446 and SN74LS449 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE

ENABLE $\overline{G}BA$	ENABLE $\overline{G}AB$	DIRECTION DIR	OPERATION 'LS446	OPERATION 'LS449
H	H	X	Isolation	Isolation
X	L	H	$\overline{A}$ data to B Bus	A data to B Bus
L	X	L	$\overline{B}$ data to A Bus	B data to A Bus
X	H	H	Isolation	Isolation
H	X	L	Isolation	Isolation

H = high level, L = low level, X = irrelevant

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Off-state output voltage . . . . . 5.5 V
Operating free-air temperature range: SN54LS' . . . . . −55°C to 125°C
SN74LS' . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1: Voltage values are with respect to the network ground terminal.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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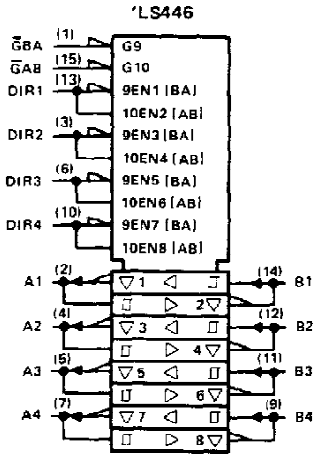
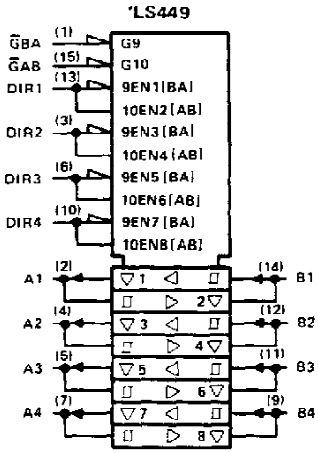
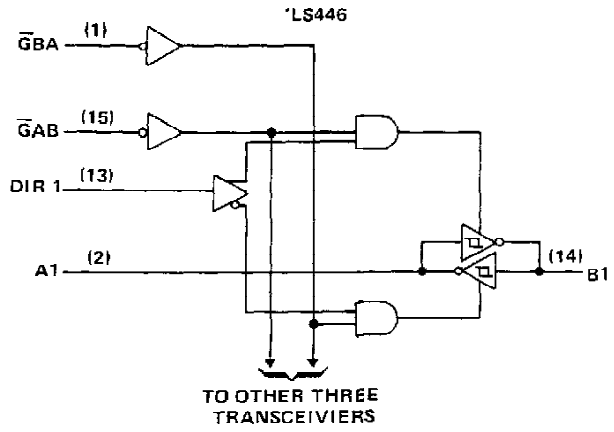
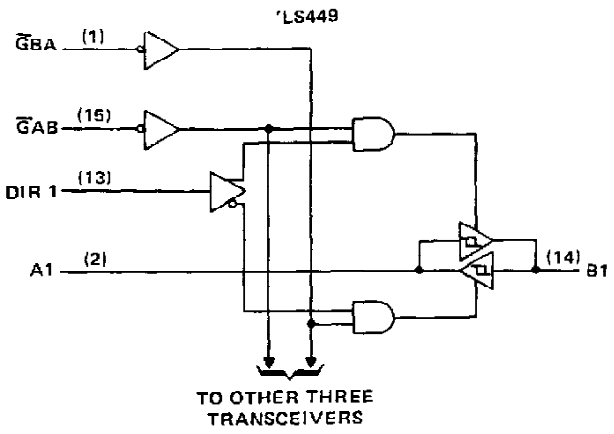
logic symbols†





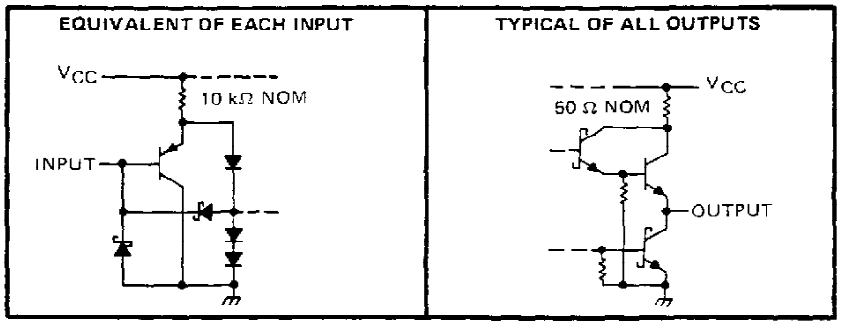
logic diagrams (positive logic)





† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, and N packages.

schematics of inputs and outputs



recommended operating conditions

PARAMETER	SN54LS446 SN54LS449			SN74LS446 SN74LS449			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC} (see Note 1)	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−12			−15	mA
Low-level output current, I_{OL}			12			24	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

NOTE 1: Voltage values are with respect to network ground terminal.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54LS446 SN54LS449			SN74LS446 SN74LS449			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.6			0.7	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
	Hysteresis ($V_{T+} - V_{T-}$), A or B input		V_{CC} = MIN		0.1	0.4		0.2	0.4		V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OH} = −3 mA	2.4	3.4		2.4	3.4		V
				I_{OH} = MAX	2			2			
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL} max	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
				I_{OL} = 24 mA					0.35	0.5	
I_{OZH}	Off-state output current, high-level voltage applied		V_{CC} = MAX, V_O = 2.7 V	$\overline{G}$ at 2 V,			20			20	μA
I_{OZL}	Off-state output current, low-level voltage applied		V_{CC} = MAX, V_O = 0.4 V	$\overline{G}$ at 2 V,			−0.4			−0.4	mA
I_I	Input current at maximum input voltage	A or B	V_{CC} = MAX,	V_I = 5.5 V			0.1			0.1	mA
		$\overline{G}$AB or $\overline{G}$BA		V_I = 7 V			0.1			0.1	
I_{IH}	High-level input current		V_{CC} = MAX,	V_I = 2.7 V			20			20	μA
I_{IL}	Low-level input current		V_{CC} = MAX,	V_I = 0.4 V			−0.4			−0.4	mA
I_{OS}	Short-circuit output current§		V_{CC} = MAX		−40		−225	−40		−225	mA
I_{CC}	Total supply current	'LS446	V_{CC} = MAX, Outputs open	Outputs high		35	56		35	56	mA
				Outputs low		39	63		39	63	
				Outputs at Hi-Z		42	68		42	68	
		'LS449		Outputs high		42	68		42	68	
				Outputs low		47	75		47	75	
				Outputs at Hi-Z		50	80		50	80	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

switching characteristics at V_{CC} = 5 V, T_A = 25°C

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS446			'LS449			UNIT
					MIN	TYP	MAX	MIN	TYP	MAX	
t_{PLH}	Propagation delay time, low-to-high-level output	A	B	C_L = 45 pF, R_L = 667 Ω, See Note 2		8	13		10	15	ns
		B	A			8	13		10	16	
t_{PHL}	Propagation delay time, high-to-low-level output	A	B			7	12		11	17	ns
		B	A			7	12		11	17	
t_{PZL}	Output enable time to low level	$\overline{G}$BA	A			24	40		21	35	ns
		$\overline{G}$AB	B			24	40		21	35	
t_{PZH}	Output enable time to high level	$\overline{G}$BA	A			15	25		18	30	ns
		$\overline{G}$AB	B			15	25		18	30	
t_{PLZ}	Output disable time from low level	$\overline{G}$BA	A	C_L = 5 pF, R_L = 667 Ω, See Note 2		14	25		14	25	ns
		$\overline{G}$AB	B			14	25		14	25	
t_{PHZ}	Output disable time from high level	$\overline{G}$BA	A			10	15		10	15	ns
		$\overline{G}$AB	B			10	15		10	15	

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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